

Aurelia

Microelettronica S.p.A.

LEGNARO 2005

**‘CAN BUS PHYSICAL LAYER
RAD TEST’**



Via Giuntini, 13 - I 56023 Cascina (Italy)
Phone: +39.050.754260 Fax: +39.050.754261
E-mail: contactus@aurelia-micro.it URL: <http://www.aurelia-micro.it>

- This design arises from the need to provide space community with a CAN 2.0B protocol with embedded micro-processor and a CAN physical layer up to 1Mbit/s, since space community is adopting CAN communication systems for spaceaircraft and satellite applications.
- CAN ISO 11898 standard, that takes in Bosch 2.0 protocol, has a large use in automotive environment, and it is integrated in many commercial technologies, but no rad hard devices are available on the market

- ISO11898 imposes high voltage technology has to be used for CAN Transceiver implementation.

Since no rad hard high voltage technology is available in Europe at low costs, AMS CXZ 0.8um high voltage technology has been selected: product has been rad hardened by design, and rad test has been performed after silicon out to characterize the transceiver behaviour in a radiation environment.

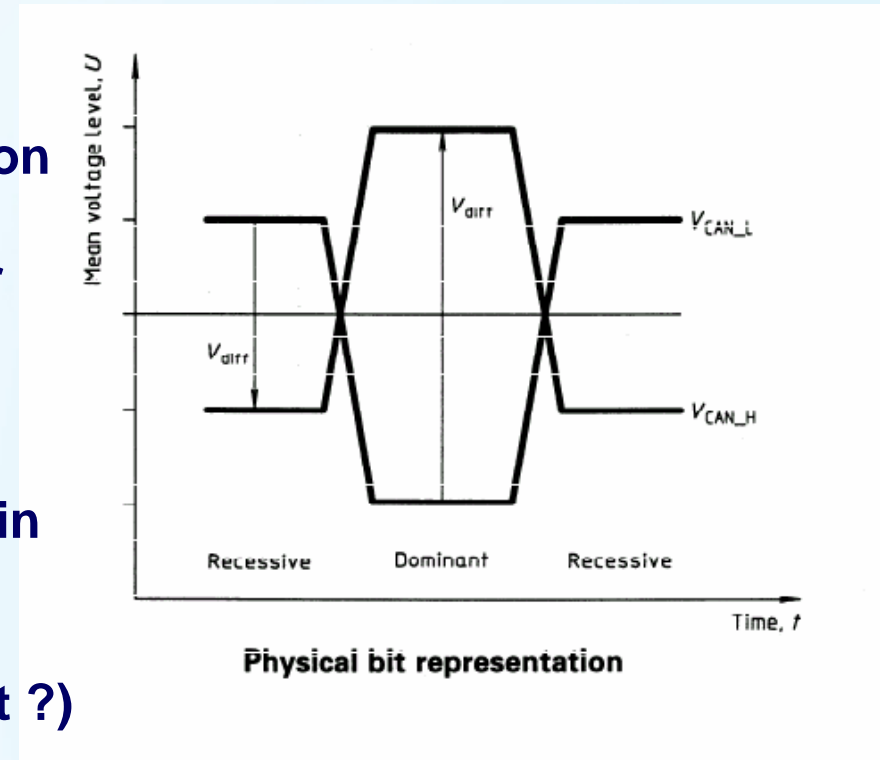
Selected technology has been tested in a rad-hard environment to verify Single Event Effects performances

- Starting points for the design are:
 - Philips TJA1050 high speed and PCA82C250 transceiver datasheet
 - ISO 11898 CAN Standard

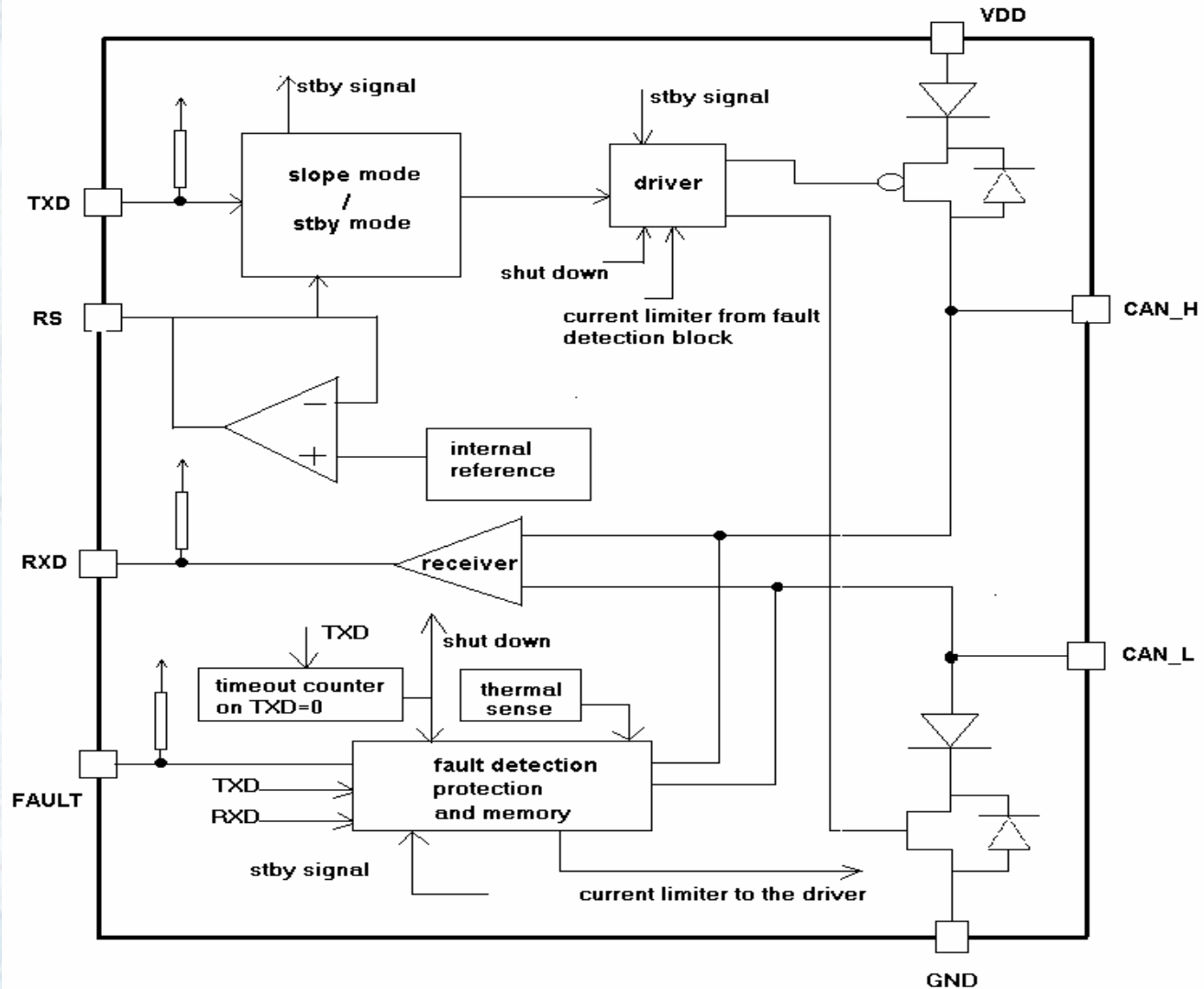
ISO11898 Standard Main Requirements on CAN Physical Layer

Physical layer goals:

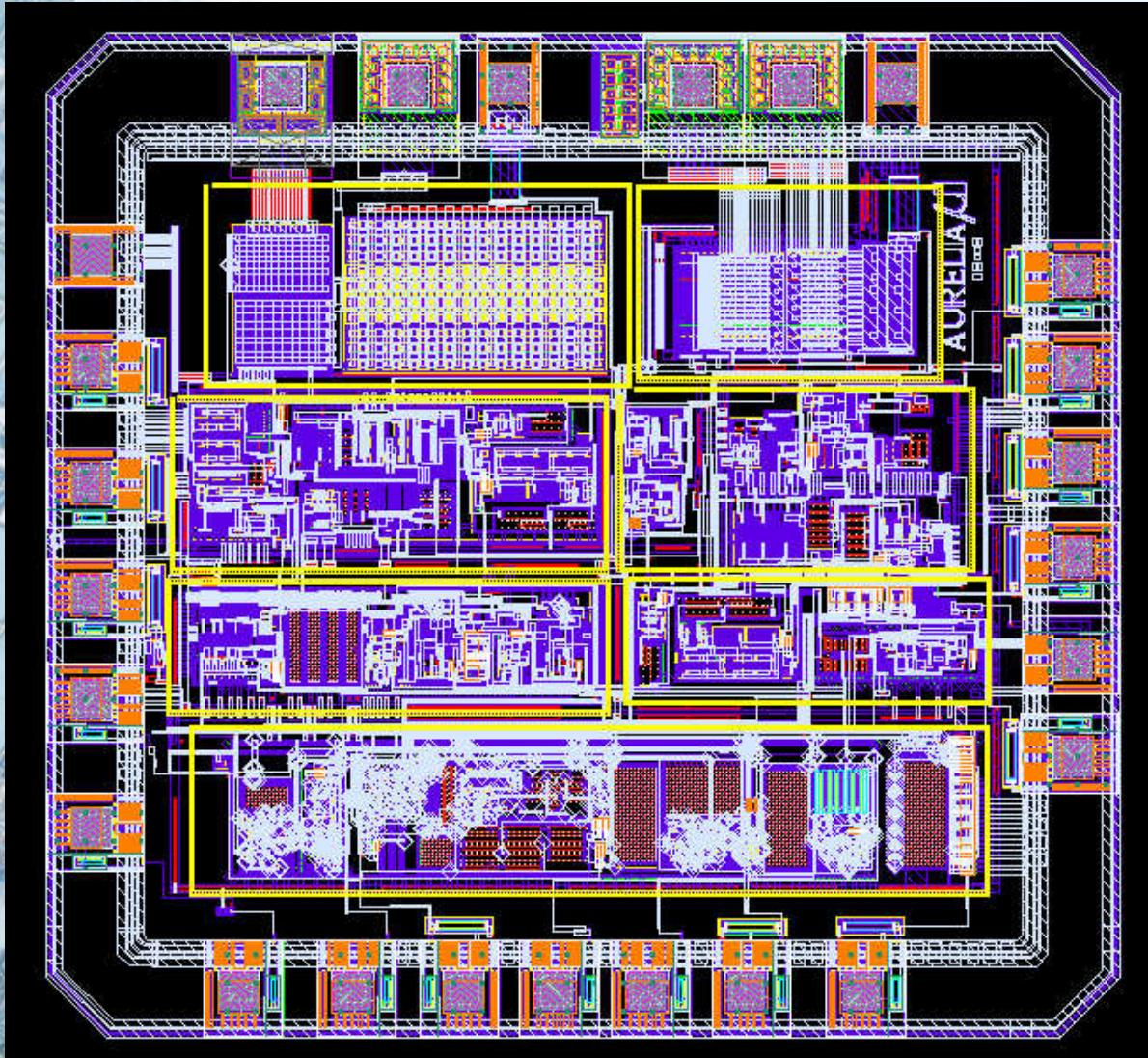
- To provide a differential representation of a logical bit on two bus wires according to a logic input pin TX , for EMI safe operation
- To assure transmission speed up to 1Mbps in the high speed version
- To provide common mode immunity in reception mode
- To measure the differential representation (recessive ? dominant ?)
- And return its logic value on a dedicated logic output pin RX
- To provide fault protection circuitry and diagnostics on the bus wires



CAN Transceiver Block Diagram



Layout Photo



Die Size:

2.5 X 2.4 mm²

Technology:

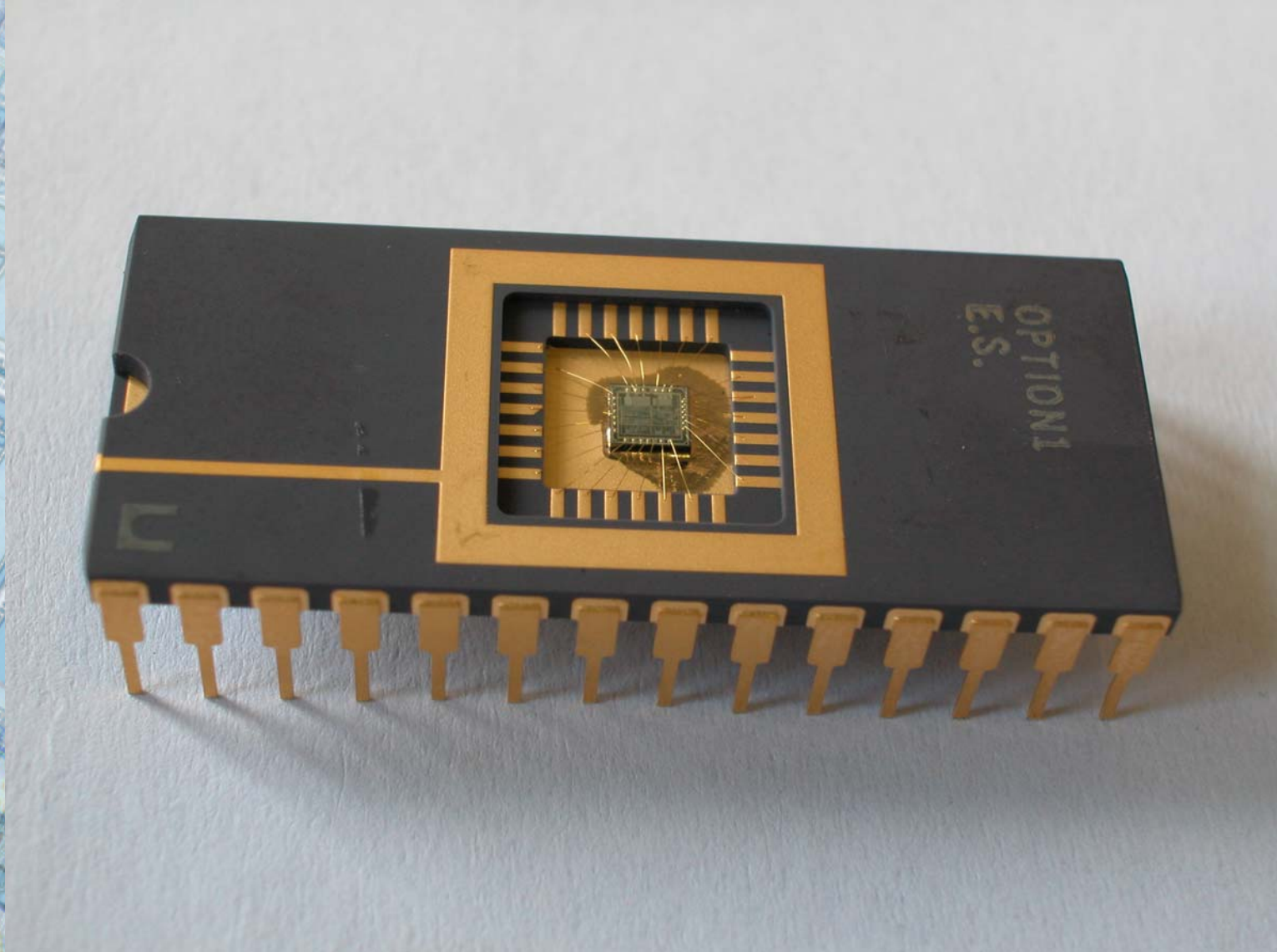
0.8um CXZ AMS

Number of masks: 17

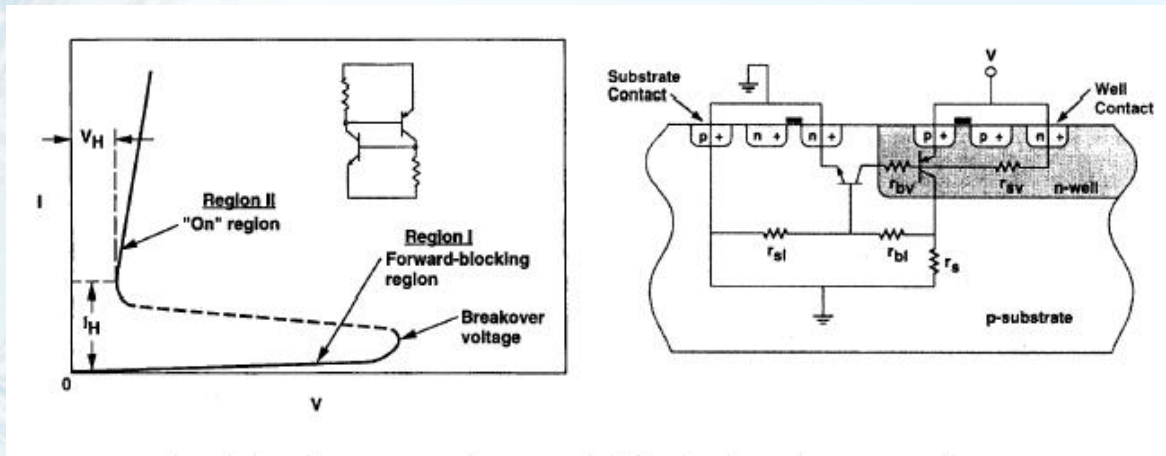
**Assembled in ceramic
DIL28,
but SO8 compatible**

**Only 8 pins have to be
bonded, all the others
are for test purposes
only**

Chip Photo



Layout main concerns: SEL and TID tolerance

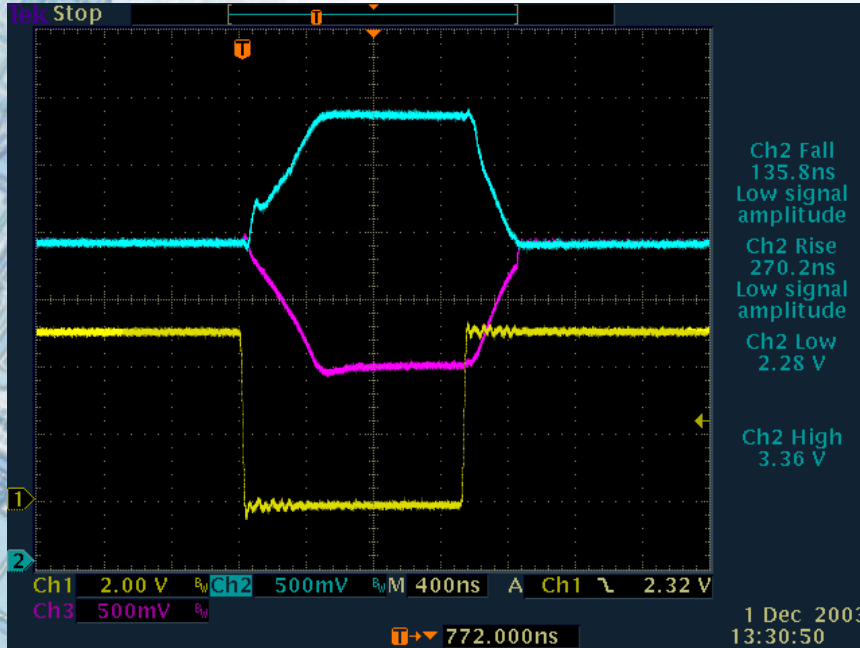


Heavy SEL concern because of:

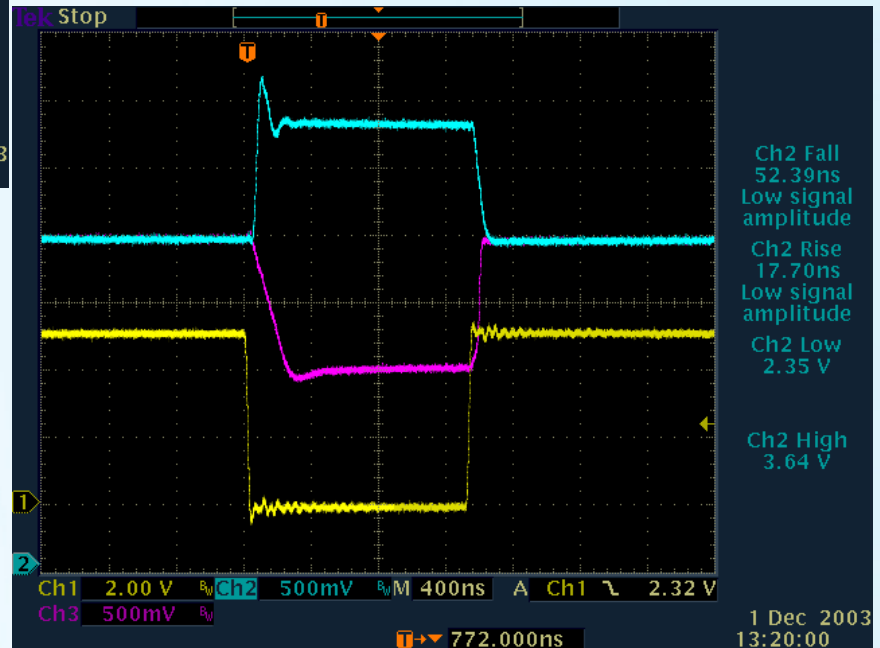
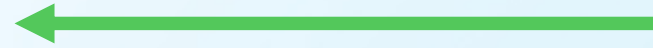
- the HV process => high sub resistance ($20 \Omega \cdot \text{cm}$)
- Underground and overbattery specifications, that require direct polarization for HV n well cathodes

TID should heavily effect on static parameters, because of the relatively large tox (17nm)

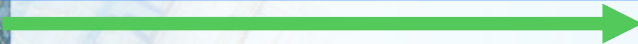
Waveforms (2/3)

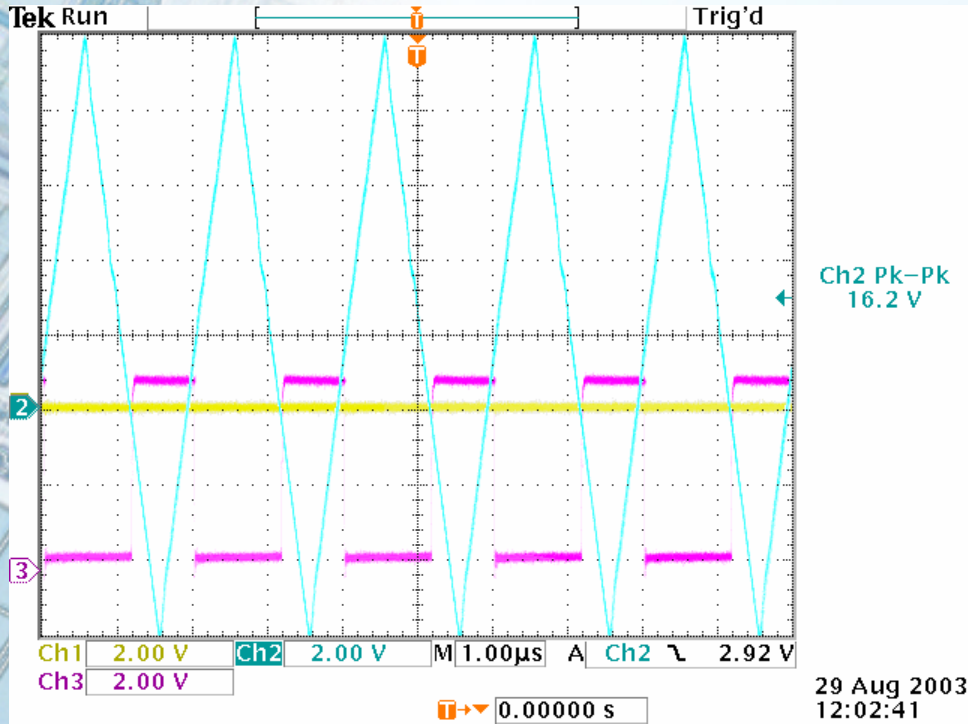


Slew rate control mode



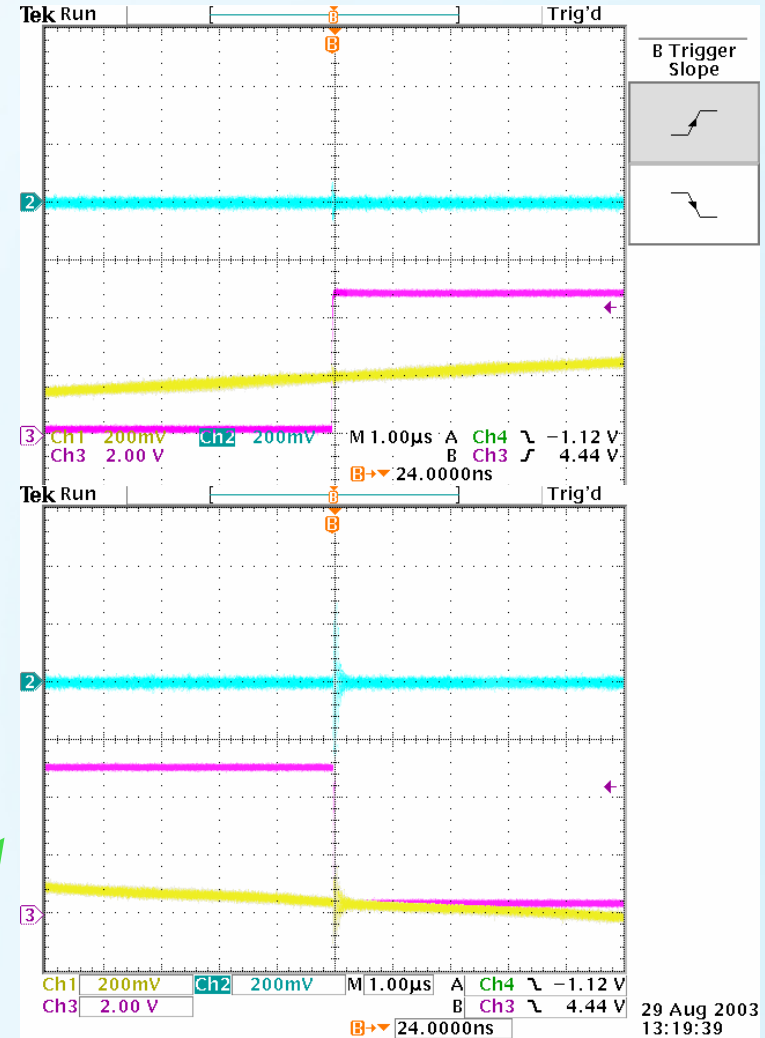
**Uncontrolled mode,
maximum speed**

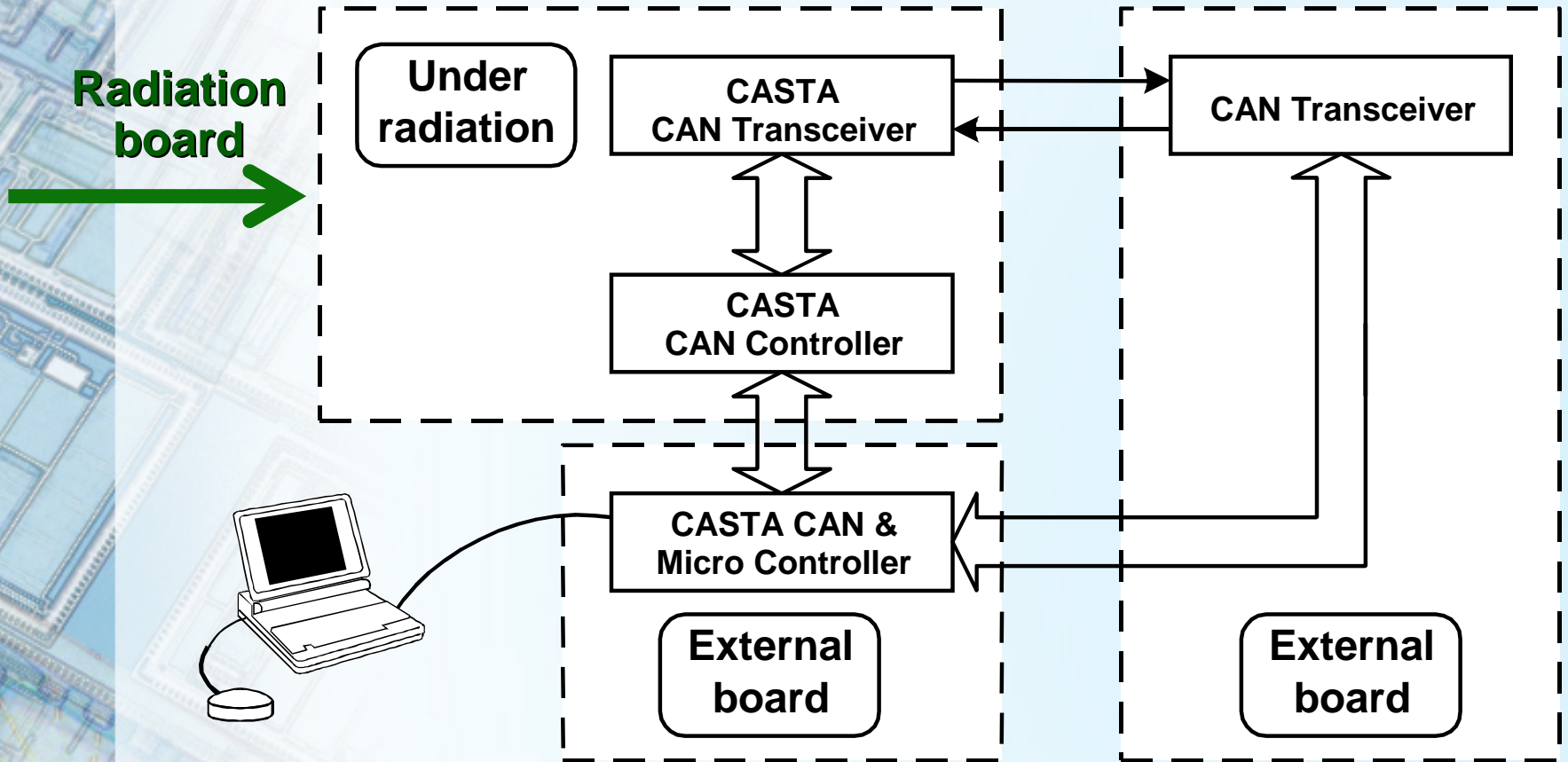




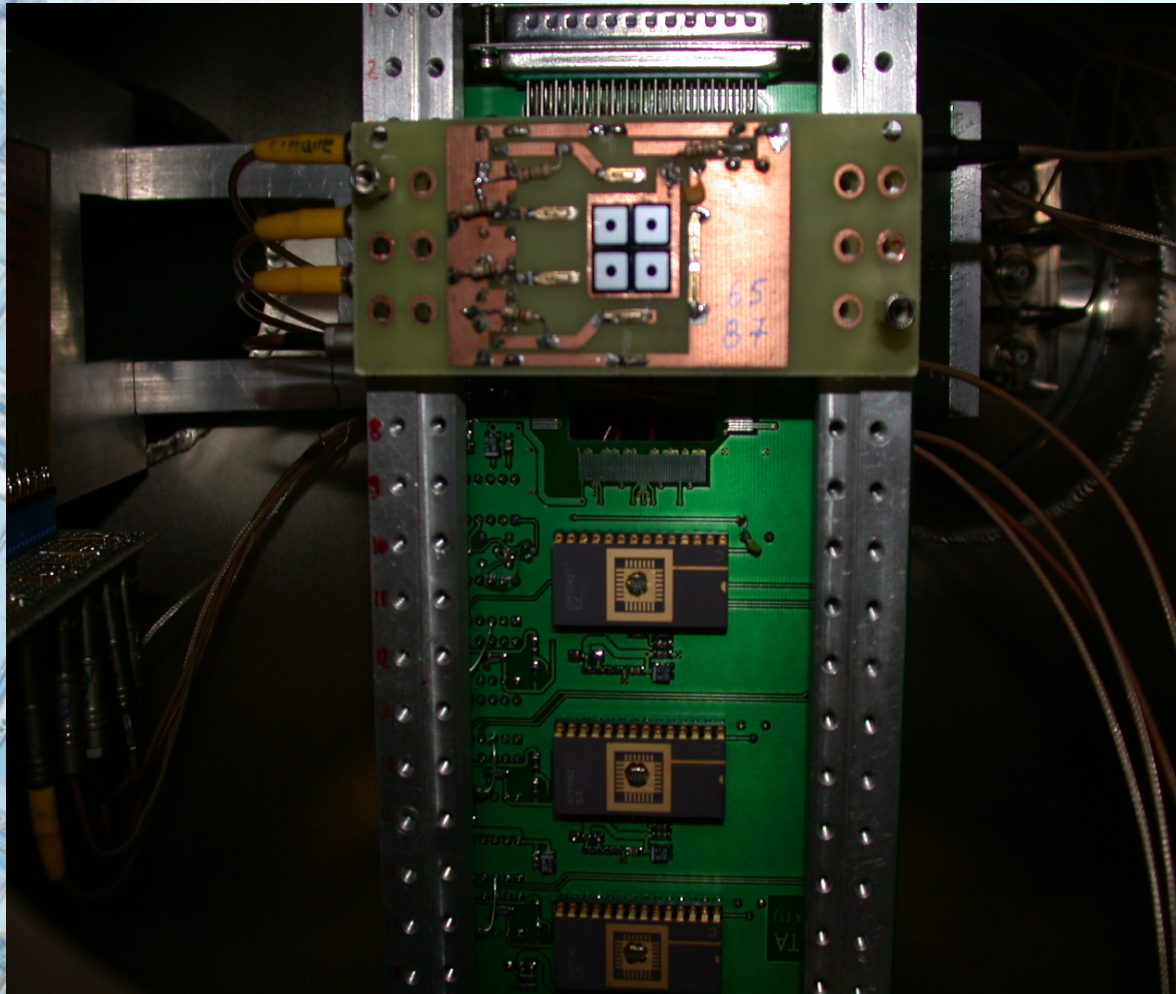
Receiver common mode immunity test

Receiver thresholds test D/R and R/D





Test setup session: mobile diodes on place holder are used for beam monitoring

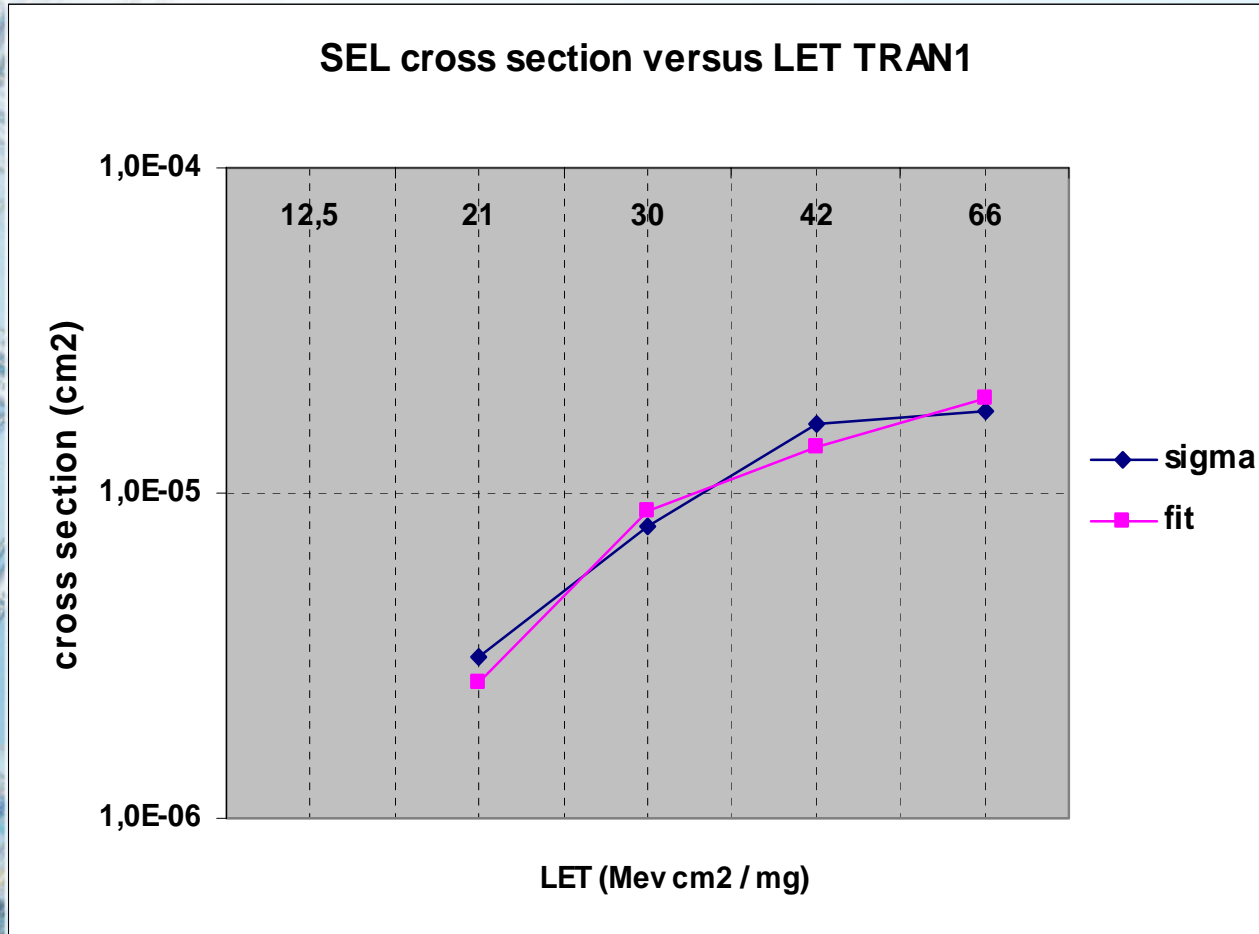


*On the board
back side,
commercial
circuitry protects
each device from
latch up: current
sense for shut off
is fully
programmable in
the range
100mA/2A for
each device*

Heavy ions used during irradiation session

Ion	Flow (ion/cm ² /s)	LET Mev xcm ² /mg
Chlorine 35	4000-25000	12.5
Bromine 79	120-3000	42
Iodine 127	100-650	66
Titane 48	1200-13000	21
Nickel 58	1600	30

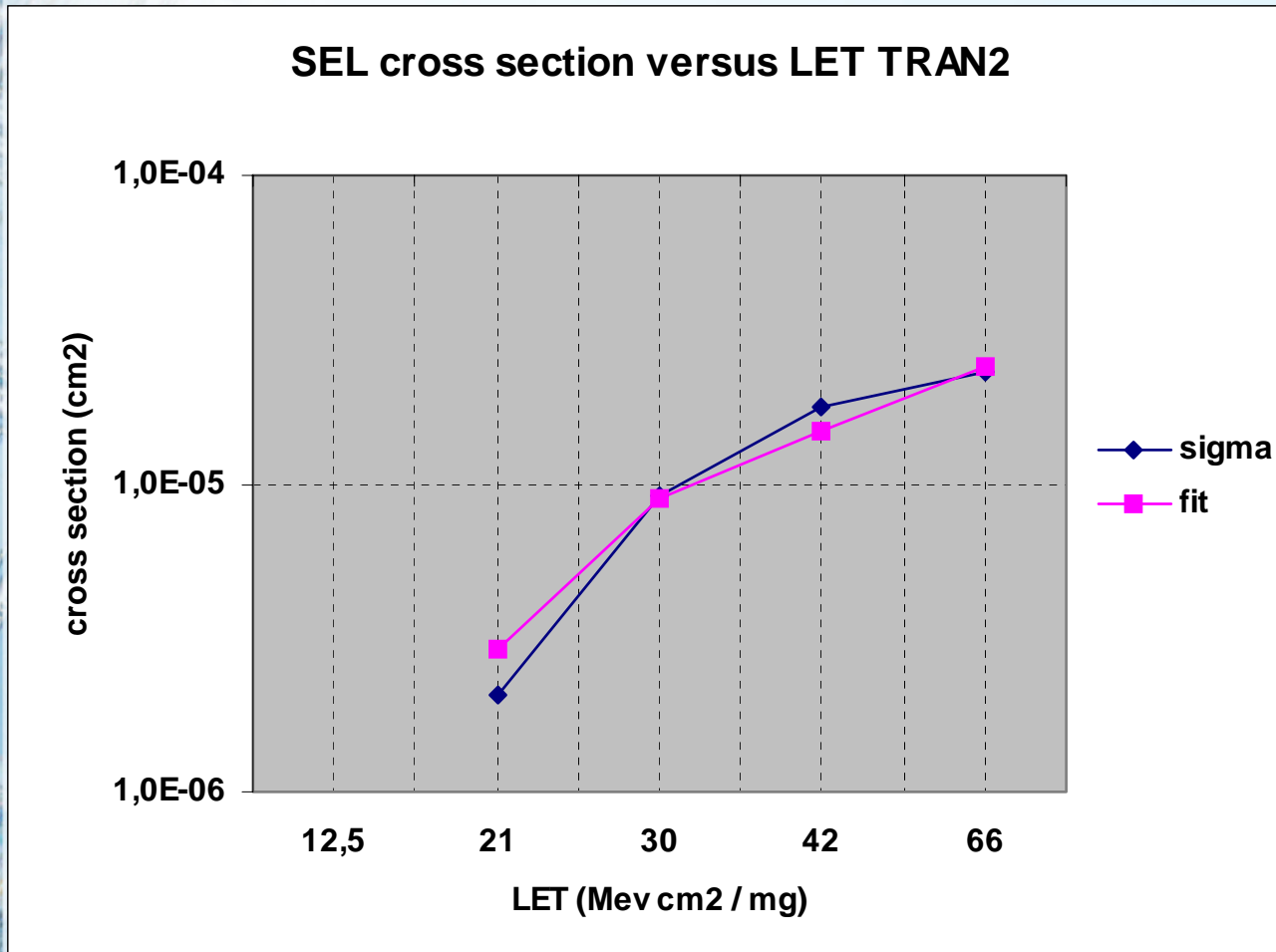
SEL Cross section versus LET on Tran device Weibull distribution



Weibull interpolated threshold for TRAN1 was 19 MeV cm² / mg

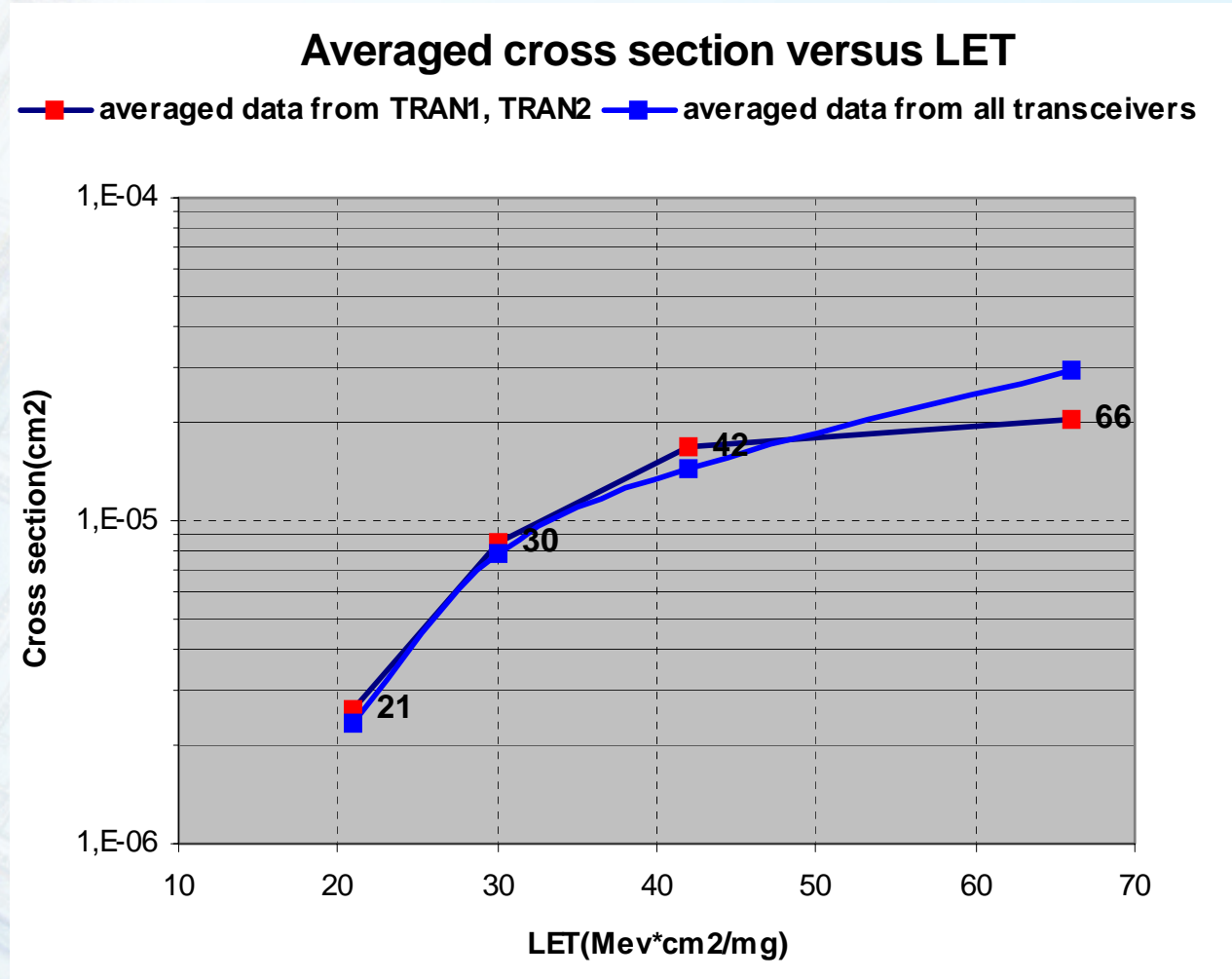
Saturation cross section equals 2.7E-5 cm²

SEL Cross section versus LET on Tran device Weibull distribution



Weibull interpolated threshold for TRAN2 was 18 MeV cm² / mg

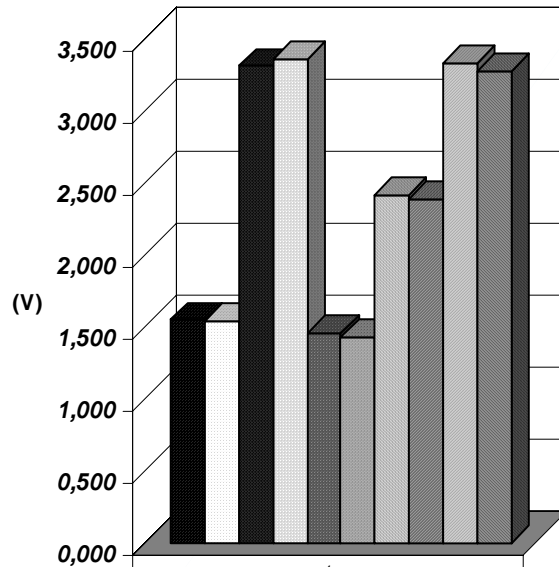
Saturation cross section equals 3.14E-5 cm²



ion	TR1 dose (rad)	TR2 dose (rad)	TR3 dose (rad)
Chlorine 35 E=178MeV LET=12.5 Mev*cm ² /mg	6560	600	0
Bromine 79 E=250 Mev LET=42 Mev*cm ² /mg	3203	2815	322
Iodine 127 E=289 MeV LET=66 Mev*cm ² /mg	528	572	530
Titane 48 E=200 MeV LET= 21 Mev*cm ² /mg	672	672	3360
Nickel 58 E=210 MeV LET=30 Mev*cm ² /mg	4800	4800	4800
Total dose	15763	9459	9012

Transceiver retesting after irradiation

comparing parameters before and after irradiation on TR1 (sample #20): total dose=15763 rad

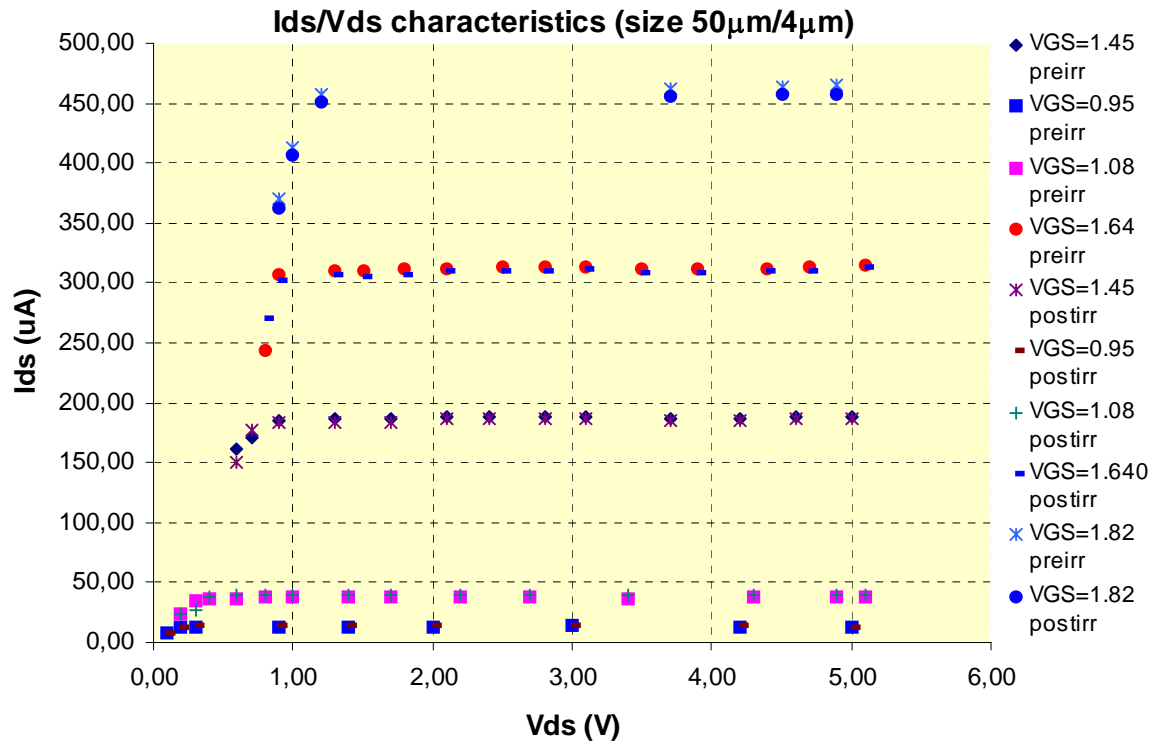


■ CAN_L post irr	1,542
▨ CAN_L pre irr	1,540
■ CAN_H post irr	3,301
▨ CAN_H pre irr	3,350
■ V15 post irr	1,448
▨ V15 pre irr	1,420
■ V25 post irr	2,411
▨ V25 pre irr	2,375
■ V35 post irr	3,318
▨ V35 pre irr	3,262

	Percentage Gap (p_post-p_pre) /p_pre
CAN_L	+0.13%
CAN_H	-1.46%
V15	+1.97%
V25	+1.52%
V35	+1.72%

Electrical parameters did not shift as an irradiation effect

Test structure retesting after irradiation



N-mos electrical characteristics did not move as a total dose effect: percentage errors with respect to the pre-irradiation measurement resulted inside the measurement accuracy. Gate Drain Leakage current still resulted < 10nA

- An ISO11898 compliant CAN transceiver has been developed in commercial AMS 0.8um High Voltage technology and it has been tested in a radiation environment at SIRAD irradiation facility. Number of tested sample is 3.
- Extrapolated LET threshold from Weibull distribution resulted in $20\text{MeV} * \text{cm}^2 / \text{mg}$
- TID was measured in 15Krad. Leakage tests and static characteristics re-tracing after irradiation showed no degradation in performances

Finally, we thank A. Candelori (Padua INFN) and M. Ceschia (Padua DEI) for their work during test plan fixing, test setup and irradiation test

Thanks for your attention!

